


**PRODUCT / PROCESS CHANGE INFORMATION**

**1. PCI basic data**

1.1 Company		STMicroelectronics International N.V
1.2 PCI No.	AMS/20/12373	
1.3 Title of PCI	New Change Carrier Tape and Cover Tape vendor for AMS GPA SOT223 Product	
1.4 Product Category	See product list	
1.5 Issue date	2020-10-02	

**2. PCI Team**

<b>2.1 Contact supplier</b>	
2.1.1 Name	NEMETH KRISZTINA
2.1.2 Phone	+49 89460062210
2.1.3 Email	krisztina.nemeth@st.com
<b>2.2 Change responsibility</b>	
2.2.1 Product Manager	Marcello SAN BIAGIO
2.1.2 Marketing Manager	Salvatore DI VINCENZO
2.1.3 Quality Manager	Giuseppe LISI

**3. Change**

<b>3.1 Category</b>	<b>3.2 Type of change</b>	<b>3.3 Manufacturing Location</b>
Materials	New Indirect material part number (same supplier or different supplier): Boxes, trays, carriers, back grinding tape, wafer mounting tape, mold tape, etc..	Nantong Fujitsu - China

**4. Description of change**

	<b>Old</b>	<b>New</b>
<b>4.1 Description</b>	Carrier: Model: TFME-EMB-X0060 Supplier: KOSTAT  Cover: Model: ALS-ATA(PRA) 0.055mm*9.5mm*480m Supplier: DENKA	Carrier: Model: TFME-EMB-X0202 Supplier: Wuxi Furun  Cover: Model: CSL-Z7302-9.5mm Supplier: SUMITOMO
<b>4.2 Anticipated Impact on form,fit, function, quality, reliability or processability?</b>	No impact	

**5. Reason / motivation for change**

<b>5.1 Motivation</b>	Current vendor for Carrier Tape and cover Tape is stopping the supply so we will switch to a new one to guarantee service continuity.
<b>5.2 Customer Benefit</b>	SERVICE CONTINUITY

**6. Marking of parts / traceability of change**

<b>6.1 Description</b>	Date code
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**7. Timing / schedule**

<b>7.1 Date of qualification results</b>	2020-10-01
<b>7.2 Intended start of delivery</b>	2020-11-15
<b>7.3 Qualification sample available?</b>	Upon Request

**8. Qualification / Validation**

<b>8.1 Description</b>	
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8.2 Qualification report and qualification results	In progress	Issue Date	
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<b>9. Attachments (additional documentations)</b>
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12373 Public product.pdf
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<b>10. Affected parts</b>
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10. 1 Current		10.2 New (if applicable)
10.1.1 Customer Part No	10.1.2 Supplier Part No	10.1.2 Supplier Part No
	LD29080S33R	
2778097	LDL1117S12R	
2778098	LDL1117S15R	
2778099	LDL1117S18R	
2778100	LDL1117S25R	
2778101	LDL1117S30R	

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